

**900V 2.1Ω Super Junction Power MOSFET****Description**

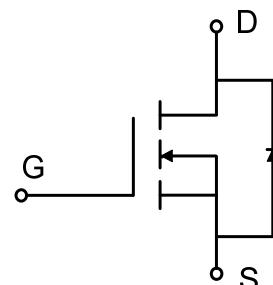
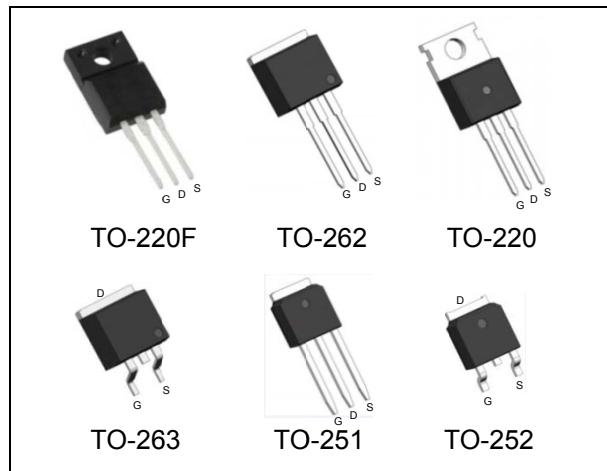
WMOS™ C2 is Wayon's 2<sup>nd</sup> generation super junction MOSFET family that is utilizing charge balance technology for extremely low on-resistance and low gate charge performance. WMOS™ C2 is suitable for applications which require superior power density and outstanding efficiency.

**Features**

- $V_{DS} = 950V @ T_{j,max}$
- Typ.  $R_{DS(on)} = 2.1\Omega$
- 100% UIS tested
- Pb-free plating, Halogen free

**Applications**

LED Lighting, Charger, Adapter, PC, LCD TV, Server

**Absolute Maximum Ratings**

Parameter	Symbol	WMK/WMM/WMO/WMP/WMN	WML	Unit
Drain-source voltage	$V_{DSS}$	900		V
Continuous drain current <sup>1)</sup> ( $T_C = 25^\circ C$ )	$I_D$	5.7		A
( $T_C = 100^\circ C$ )		3.1		A
Pulsed drain current <sup>2)</sup>	$I_{DM}$	10		A
Gate-source voltage	$V_{GS}$	$\pm 30$		V
Avalanche energy, single pulse <sup>3)</sup>	$E_{AS}$	55		mJ
Avalanche energy, repetitive <sup>2)</sup>	$E_{AR}$	0.15		mJ
Avalanche current, repetitive <sup>2)</sup>	$I_{AR}$	1.2		A
Power dissipation ( $T_C = 25^\circ C$ )	$P_D$	57	27	W
- Derate above 25°C		0.46	0.22	W/°C
Operating and storage temperature range	$T_j, T_{stg}$	-55 to +150		°C
Continuous diode forward current	$I_S$	5.7		A
Diode pulse current	$I_{S,pulse}$	10		A

**Thermal Characteristics**

Parameter	Symbol	WMK/WMM/WMO/WMP/WMN	WML	Unit
Thermal resistance, junction-to-case	$R_{\theta JC}$	2.2	4.6	°C/W
Thermal resistance, junction-to-ambient	$R_{\theta JA}$	62	80	°C/W

**Electrical Characteristics**  $T_c = 25^\circ\text{C}$ , unless otherwise noted

Parameter	Symbol	Test Condition	Min.	Typ.	Max.	Unit
<b>Static characteristics</b>						
Drain-source breakdown voltage	$\text{BV}_{\text{DSS}}$	$V_{\text{GS}}=0 \text{ V}, I_{\text{D}}=0.25 \text{ mA}$	900	-	-	V
Gate threshold voltage	$V_{\text{GS}(\text{th})}$	$V_{\text{DS}}=V_{\text{GS}}, I_{\text{D}}=0.25 \text{ mA}$	2.5	3.3	4.5	V
Drain cut-off current	$I_{\text{DSS}}$	$V_{\text{DS}}=900 \text{ V}, V_{\text{GS}}=0 \text{ V},$ $T_j = 25^\circ\text{C}$ $T_j = 125^\circ\text{C}$	-	-	1	$\mu\text{A}$
Gate leakage current, forward	$I_{\text{GSSF}}$	$V_{\text{GS}}=30 \text{ V}, V_{\text{DS}}=0 \text{ V}$	-	-	100	nA
Gate leakage current, reverse	$I_{\text{GSSR}}$	$V_{\text{GS}}=-30 \text{ V}, V_{\text{DS}}=0 \text{ V}$	-	-	-100	nA
Drain-source on-state resistance	$R_{\text{DS}(\text{on})}$	$V_{\text{GS}}=10 \text{ V}, I_{\text{D}}=1 \text{ A}$ $T_j = 25^\circ\text{C}$	-	2.1	2.5	$\Omega$
<b>Dynamic characteristics</b>						
Input capacitance	$C_{\text{iss}}$	$V_{\text{DS}}=25 \text{ V}, V_{\text{GS}}=0 \text{ V},$ $f = 1 \text{ MHz}$	-	450	-	pF
Output capacitance	$C_{\text{oss}}$		-	36	-	
Reverse transfer capacitance	$C_{\text{rss}}$		-	1.4	-	
Turn-on delay time	$t_{\text{d}(\text{on})}$	$V_{\text{DD}} = 300 \text{ V}, I_{\text{D}} = 1.5 \text{ A}$ $R_G = 25 \Omega, V_{\text{GS}}=10 \text{ V}$	-	21	-	ns
Rise time	$t_r$		-	12	-	
Turn-off delay time	$t_{\text{d}(\text{off})}$		-	43	-	
Fall time	$t_f$		-	13	-	
<b>Gate charge characteristics</b>						
Gate to source charge	$Q_{\text{gs}}$	$V_{\text{DD}}=480 \text{ V}, I_{\text{D}}=1.5 \text{ A},$ $V_{\text{GS}}=0 \text{ to } 10 \text{ V}$	-	2.2	-	nC
Gate to drain charge	$Q_{\text{gd}}$		-	7.1	-	
Gate charge total	$Q_g$		-	12.8	-	
Gate plateau voltage	$V_{\text{plateau}}$		-	5.1	-	V
<b>Reverse diode characteristics</b>						
Diode forward voltage	$V_{\text{SD}}$	$V_{\text{GS}}=0 \text{ V}, I_{\text{F}}=1 \text{ A}$	-	-	1.2	V
Reverse recovery time	$t_{\text{rr}}$	$V_R=50 \text{ V}, I_{\text{F}}=1.5 \text{ A},$ $dI_{\text{F}}/dt=100 \text{ A}/\mu\text{s}$	-	190	-	ns
Reverse recovery charge	$Q_{\text{rr}}$		-	0.95	-	$\mu\text{C}$
Peak reverse recovery current	$I_{\text{rrm}}$		-	9	-	A

Notes:

1. Limited by  $T_{j\max}$ . Maximum duty cycle D=0.5.
2. Repetitive rating: pulse width limited by maximum junction temperature.
3.  $I_{AS} = 1.2 \text{ A}, V_{DD} = 50 \text{ V}, R_G = 25 \Omega$ , starting  $T_j = 25^\circ\text{C}$ .

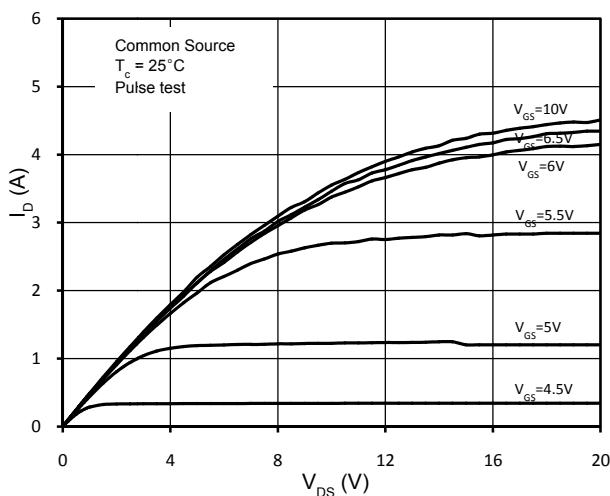


Figure 1. On-Region Characteristics

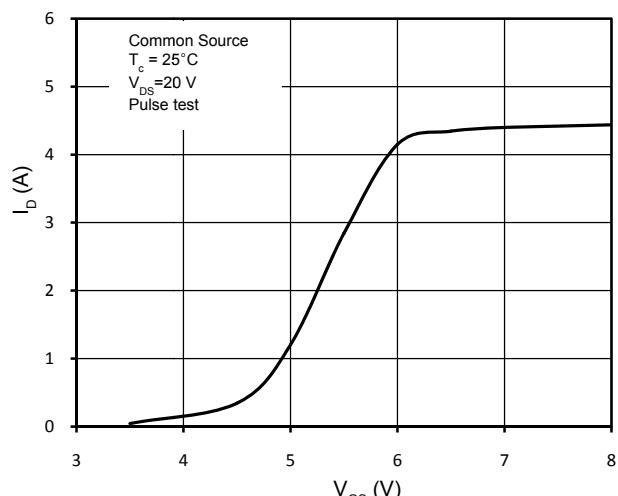


Figure 2. Transfer Characteristics

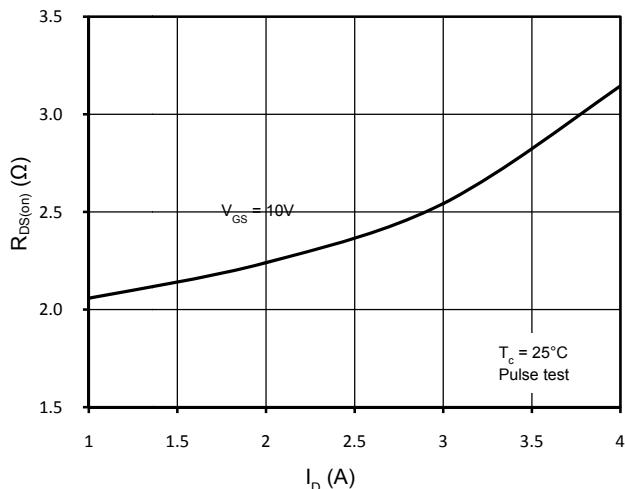


Figure 3. Static Drain-Source On Resistance

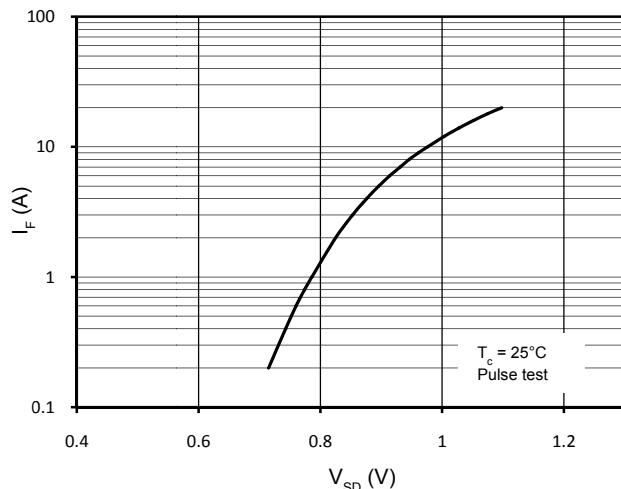
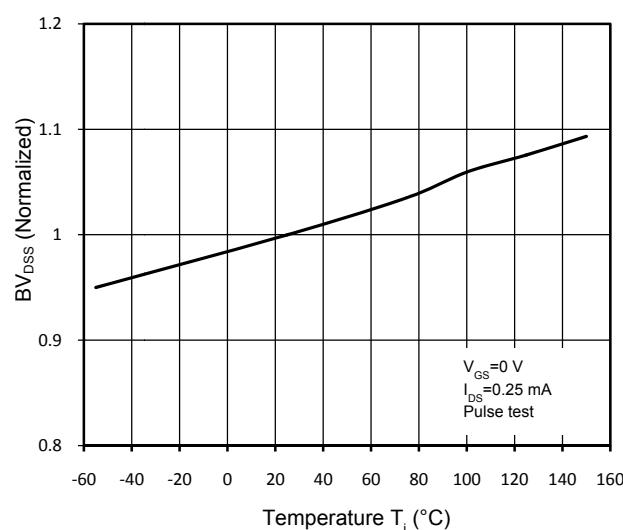
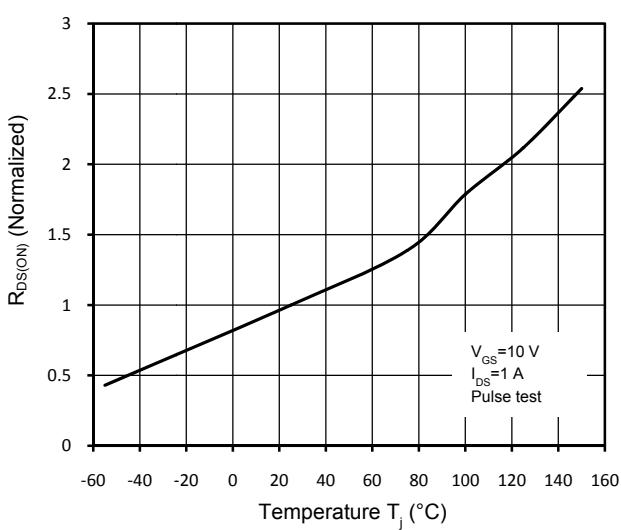


Figure 4. Body-Diode Forward Characteristics

Figure 5. Normalized BV<sub>DSS</sub> vs. TemperatureFigure 6. Normalized R<sub>DS(on)</sub> vs. Temperature

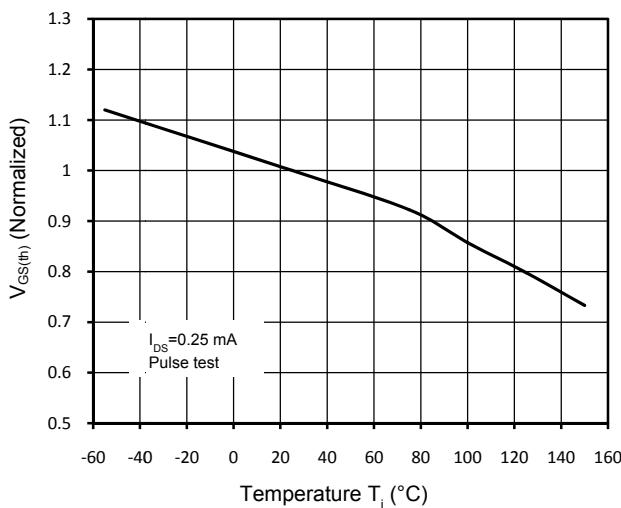


Figure 7. Threshold Voltage vs. Temperature

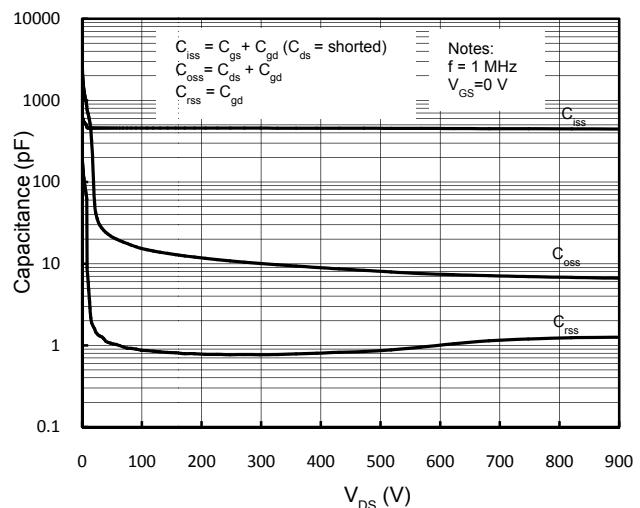


Figure 8. Capacitance Characteristics

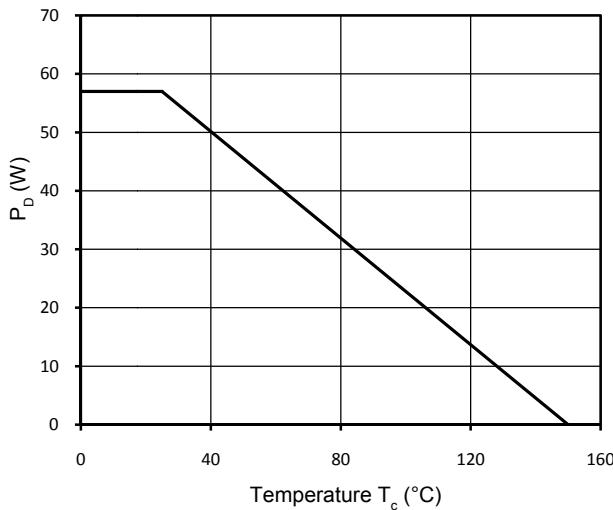


Figure 9. Power Dissipation

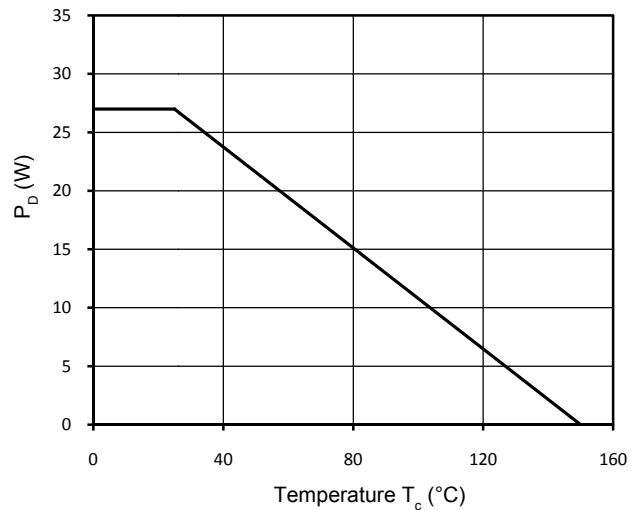


Figure 10. Power Dissipation (TO-220F)

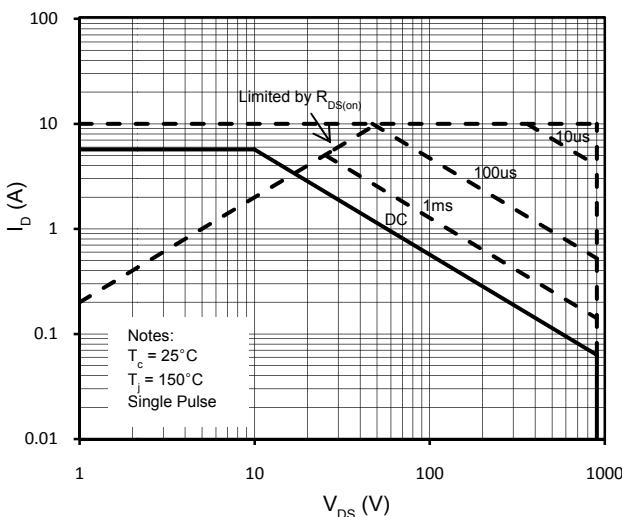


Figure 11. Maximum Safe Operating Area

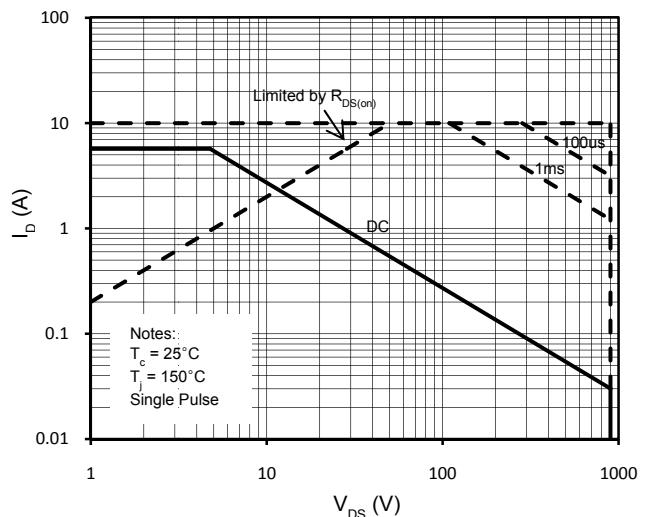


Figure 12. Maximum Safe Operating Area(TO-220F)

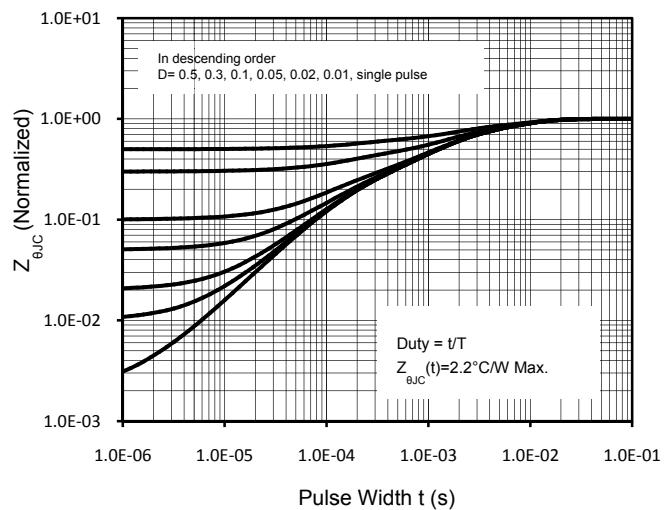
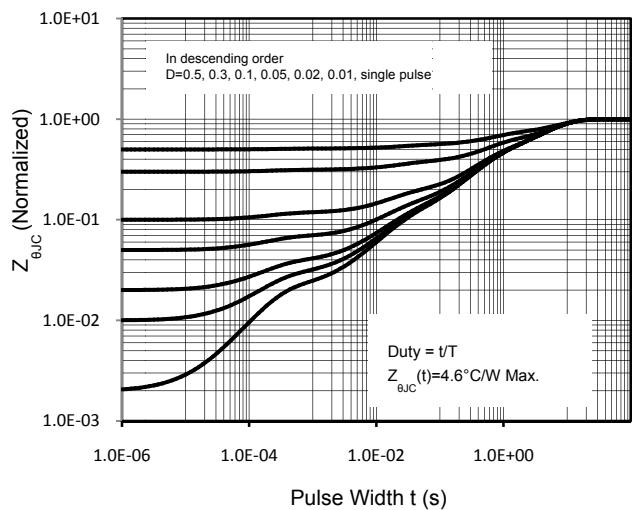


Figure 13. Transient Thermal Response Curve (TO-220F)    Figure 14. Transient Thermal Response Curve

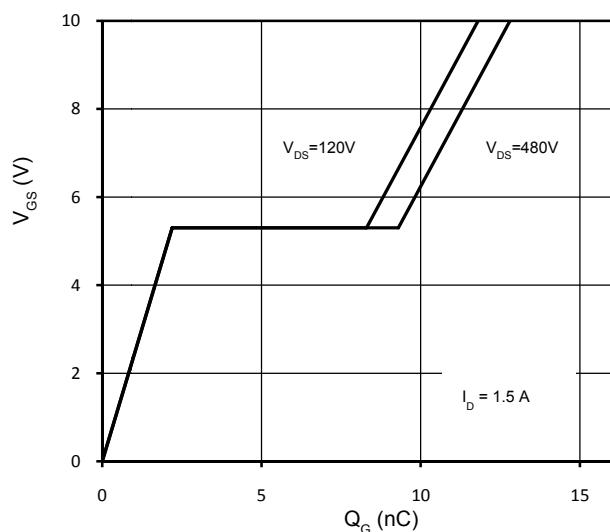
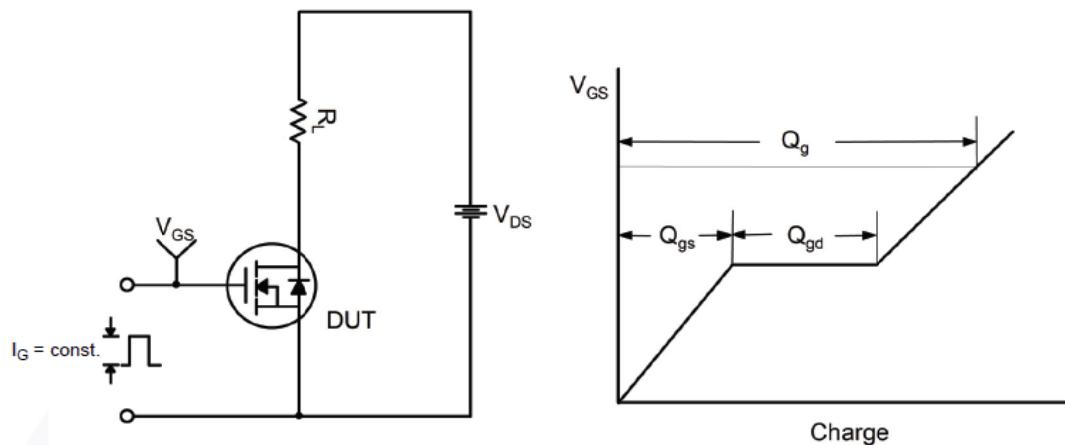
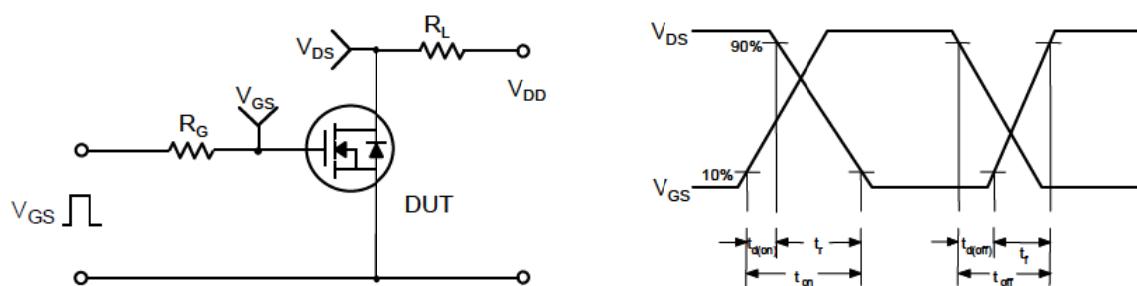
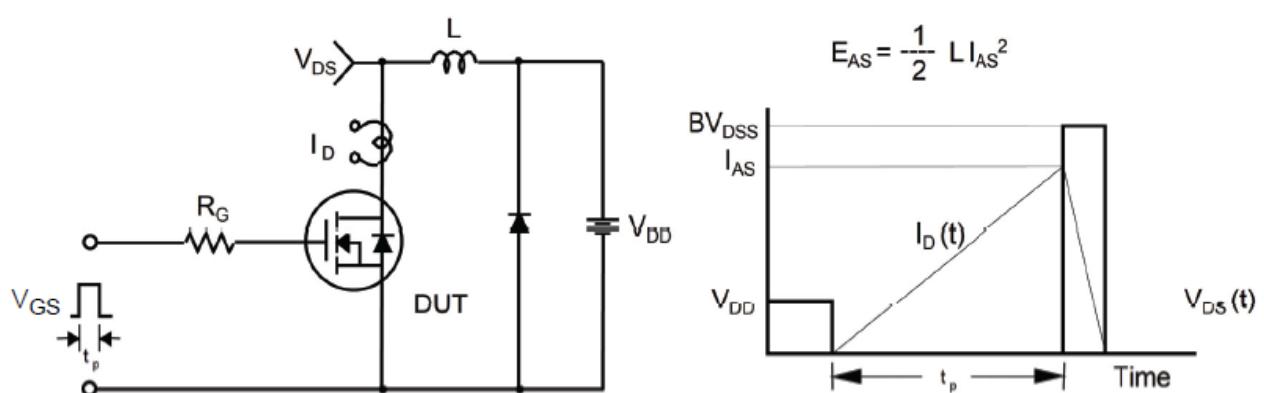
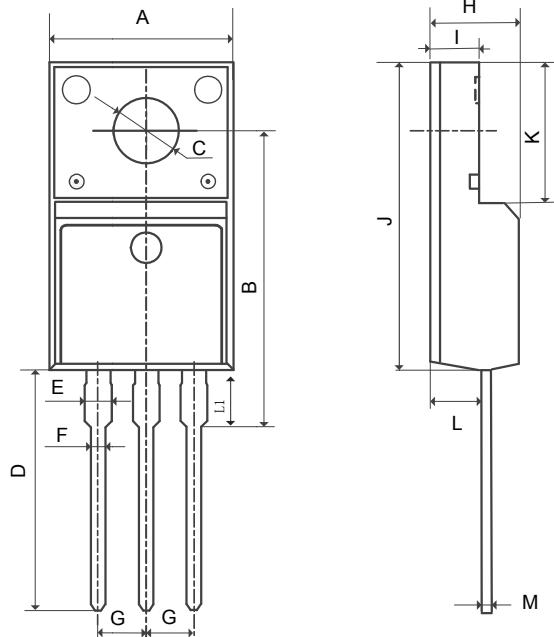
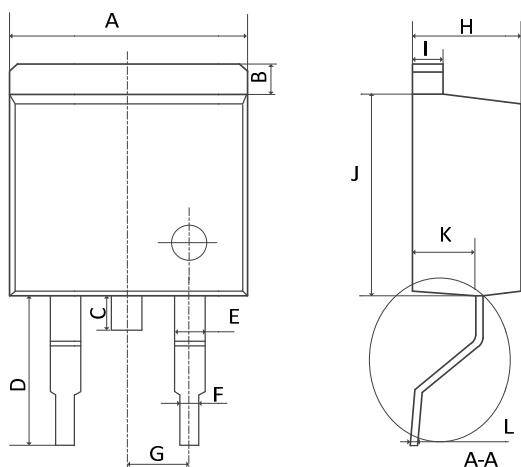


Figure 15. Gate Charge Characteristics

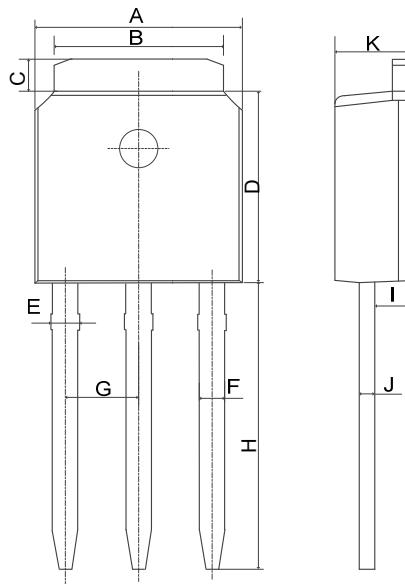
**Gate Charge Test Circuit & Waveform****Switching Test Circuit & Waveforms****Unclamped Inductive Switching Test Circuit & Waveforms**

**Mechanical Dimensions for TO-220F****COMMON DIMENSIONS**

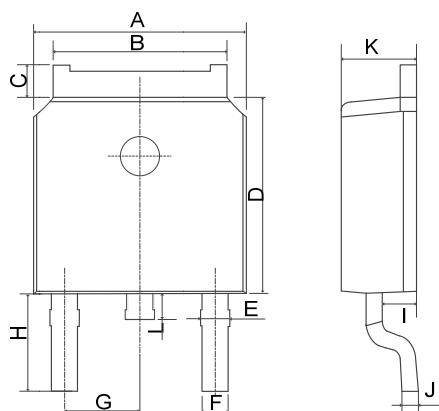
SYMBOL	MM	
	MIN	MAX
A	9.96	10.36
B	15.10	16.10
C	3.03	3.38
D	12.64	13.28
E	1.18	1.58
F	0.70	0.95
G	2.54REF	
H	4.50	4.90
I	2.34	2.74
J	15.57	16.17
K	6.70REF	
L	2.56	2.96
M	0.40	0.65
L1	2.85	3.45

**Mechanical Dimensions for TO-263****COMMON DIMENSIONS**

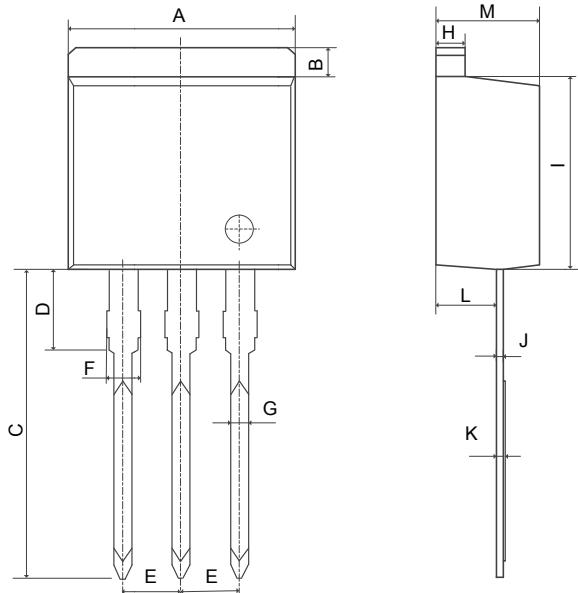
SYMBOL	MM	
	MIN	MAX
A	10.00	10.40
B	1.11	1.41
C	1.25	1.55
D	5.10	5.50
E	1.12	1.42
F	0.71	0.92
G	2.39	2.69
H	4.49	4.89
I	1.17	1.37
J	8.45	8.85
K	2.54	2.84
L	0.28	0.49

**Mechanical Dimensions for TO-251****COMMON DIMENSIONS**

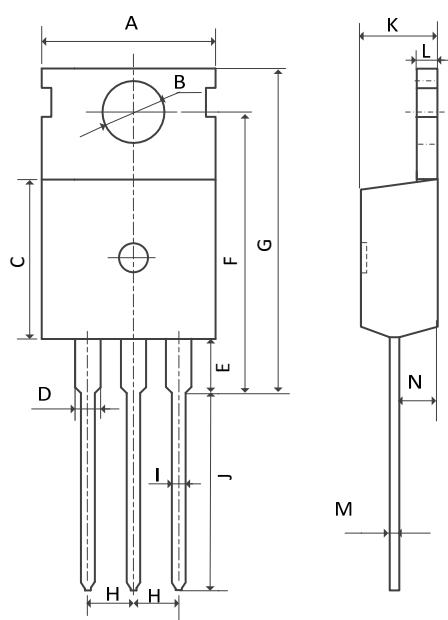
SYMBOL	MM	
	MIN	MAX
A	6.40	6.80
B	5.13	5.46
C	0.88	1.28
D	5.90	6.22
E	0.68	1.10
F	0.68	0.91
G	2.29REF	
H	9.00	9.65
I	0.90	1.17
J	0.40	0.61
K	2.10	2.50

**Mechanical Dimensions for TO-252****COMMON DIMENSIONS**

SYMBOL	MM	
	MIN	MAX
A	6.40	6.80
B	5.13	5.50
C	0.88	1.28
D	5.90	6.22
E	0.68	1.10
F	0.68	0.91
G	2.29REF	
H	2.90REF	
I	0.85	1.17
J	0.51REF	
K	2.10	2.50
L	0.40	1.00

**Mechanical Dimensions for TO-262****COMMON DIMENSIONS**

SYMBOL	MM	
	MIN	MAX
A	10.00	10.40
B	1.11	1.41
C	13.56	14.16
D	3.58	3.98
E	2.39	2.69
F	1.07	1.47
G	0.71	0.92
H	1.17	1.37
I	8.45	8.85
J	0.28	0.49
K	0.32	0.52
L	2.54	2.85
M	4.50	4.90

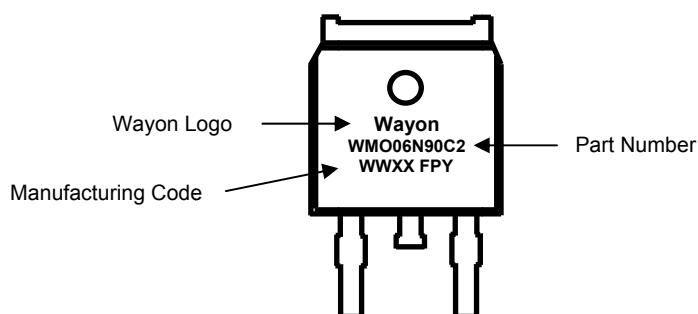
**Mechanical Dimensions for TO-220****COMMON DIMENSIONS**

SYMBOL	MM	
	MIN	MAX
A	9.70	10.20
B	3.40	3.80
C	8.90	9.40
D	1.17	1.47
E	2.60	3.40
F	15.10	16.70
G	19.55MAX	
H	2.54REF	
I	0.70	0.95
J	9.35	11.00
K	4.30	4.77
L	1.20	1.45
M	0.40	0.65
N	2.20	2.60

## Ordering Information

Part	Package	Marking	Packing method
WML06N90C2	TO-220F	WML06N90C2	Tube
WMK06N90C2	TO-220	WMK06N90C2	Tube
WMN06N90C2	TO-262	WMN06N90C2	Tube
WMM06N90C2	TO-263	WMM06N90C2	Tape and Reel
WMO06N90C2	TO-252	WMO06N90C2	Tape and Reel
WMP06N90C2	TO-251	WMP06N90C2	Tube

## Marking Information



## Contact Information

No.1001, Shiwan(7) Road, Pudong District, Shanghai, P.R.China.201202

Tel: 86-21-50310888 Fax: 86-21-50757680 Email: market@way-on.com

WAYON website: <http://www.way-on.com>

For additional information, please contact your local Sales Representative.

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